

Features

- GaN on SiC D-Mode Transistor Technology
- Unmatched, Ideal for Pulsed / CW Applications
- 50 V Typical Bias, Class AB
- Common-Source Configuration
- Thermally-Enhanced 3 x 6 mm 14-Lead DFN
- MTTF = 600 years (T_J < 200°C)
- Halogen-Free "Green" Mold Compound
- RoHS* Compliant and 260°C Reflow Compatible
- MSL-1

Description

The MAGX-000035-01000P is a GaN on SiC unmatched power device offering the widest RF frequency capability, most reliable high voltage operation, lowest overall power transistor size, cost and weight in a "TRUE SMT" plastic-packaging technology.

Use of an internal stress buffer technology allows reliable operation at junction temperatures up to 200°C. The small package size and excellent RF performance make it an ideal replacement for costly flanged or metal-backed module components.

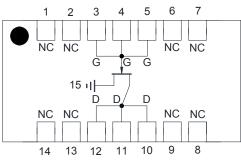
Ordering Information¹

Part Number	Package
MAGX-000035-01000P	Bulk Packaging
MAGX-000035-0100TP	500 Piece Reel
MAGX-L20035-01000P	900 - 1400 MHz Sample Board
MAGX-000035-PB4PPR	Custom Sample Board ²

1. Reference Application Note M513 for reel size information.

 When ordering this sample evaluation board, choose a standard frequency range indicated on page 4/5 or specify a desired custom range. Custom requests may increase lead times.

Functional Schematic



Pin Configuration³

Pin No.	Function	Pin No.	Function					
1	No Connection	8	No Connection					
2	No Connection	9 No Connectio						
3	V_{GG}/RF_{IN}	10	V _{DD} /RF _{OUT}					
4	V_{GG}/RF_{IN}	11	V _{DD} /RF _{OUT}					
5	V_{GG}/RF_{IN}	12	V _{DD} /RF _{OUT}					
6	No Connection	13	No Connection					
7	No Connection	14	No Connection					
		15	Paddle ⁴					

MACOM recommends connecting unused package pins to ground.

4. The exposed pad centered on the package bottom must be connected to RF and DC ground.

* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

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MACOM



GaN Wideband 10 W CW / Pulsed Transistor in Plastic Package DC - 3.5 GHz

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Typical Performance: $V_{DD} = 50 \text{ V}$, $I_{DQ} = 30 \text{ mA}$, $T_A = 25^{\circ}\text{C}$

Parameter	30 MHz	1 GHz	2.5 GHz	3.5 GHz	Units
Gain	17	15	14	14	dB
Saturated Power (P _{SAT})	13	11	10	10	W
Power Gain at P _{SAT}	15	14	13	12	dB
PAE @ P _{SAT}	65	55	53	50	%

Electrical Specifications⁵: Freq. = 1.6 GHz, $T_A = 25^{\circ}C$, $Z_0 = 50 \Omega$

Parameter	Symbol	Min.	Тур.	Max.	Units
CW RF FUNCTIONAL TESTS: V_{DD} = 50 V, I_{DQ} = 30 mA, P2.5 dB					
CW Output Power	P _{OUT}	-	10	-	W
Pulsed RF FUNCTIONAL TESTS: V_{DD} = 50 V, I_{DQ} = 30 mA, P2.5 dB, Pulsed	ty Cycle =	: 10%			
Pulsed Output Power	P _{OUT}	9.2	10.6	-	W
Pulsed Power Gain	G _P	14.2	14.8	-	dB
Pulsed Drain Efficiency	η _D	52	56	-	%
Load Mismatch Stability	VSWR-S	-	5:1	-	-
Load Mismatch Tolerance	VSWR-T	-	10:1	-	-

5. Electrical specifications measured in MACOM RF evaluation boards. See recommended tuning solutions on page 4.

Electrical Characteristics: T_A = 25°C

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units
DC CHARACTERISTICS						
Drain-Source Leakage Current	V_{GS} = -8 V, V_{DS} = 175 V	I _{DS}	-	-	1.0	mA
Gate Threshold Voltage	V_{DS} = 5 V, I _D = 2 mA	V _{GS (th)}	-5	-3	-2	V
Forward Transconductance	V_{DS} = 5 V, I _D = 250 mA	G _M	0.20	-	-	S
DYNAMIC CHARACTERISTICS						
Input Capacitance	V_{DS} = 0 V, V_{GS} = -8 V, F = 1 MHz	C _{ISS}	-	2.2	-	pF
Output Capacitance	V_{DS} = 50 V, V_{GS} = -8 V, F = 1 MHz	C _{OSS}	-	0.9	-	pF
Reverse Transfer Capacitance	V_{DS} = 50 V, V_{GS} = -8 V, F = 1 MHz	C _{RSS}	-	0.1	-	pF

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Absolute Maximum Ratings 6,7,8,9,10

Parameter	Absolute Max.
Input Power	P _{OUT} - G _P + 2.5 dBm
Drain Supply Voltage, V_{DD}	+65 V
Gate Supply Voltage, V_{GG}	-8 V to 0 V
Supply Current, I _{DD}	500 mA
Power Dissipation, CW @ 85°C	12 W
Power Dissipation (P _{AVG}), Pulsed @ 85°C	12 W
Junction Temperature ¹¹	200°C
Operating Temperature	-40°C to +95°C
Storage Temperature	-65°C to +150°C
ESD Maximum - Human Body Model (HBM)	400 V
ESD Maximum - Charged Device Model (CDM)	150 V

6. Exceeding any one or combination of these limits may cause permanent damage to this device.

7. MACOM does not recommend sustained operation near these survivability limits.

8. For saturated performance it is recommended that the sum of $(3 * V_{DD} + abs (V_{GG})) \le 175 V$.

9. CW operation at V_{DD} voltages above 50 V is not recommended.

Operating at nominal conditions with T_J ≤ 200°C will ensure MTTF > 1 x 10⁶ hours. Junction temperature directly affects device MTTF and should be kept as low as possible to maximize lifetime.

11. Junction Temperature $(T_J) = T_C + \Theta_{JC} * ((V * I) - (P_{OUT} - P_{IN}))$

Typical CW thermal resistance $(\Theta_{JC}) = 5.8^{\circ}C/W$ a) For T_C = 83°C, T_J = 124°C @ 50 V, 330 mA, P_{OUT} = 10W, P_{IN} = 0.6W

Typical transient thermal resistances:

b) 300 µs pulse, 10% duty cycle, $\Theta_{JC} = 1.94^{\circ}C/W$ For T_C = 83°C, T_J = 97°C @ 50 V, 325mA, P_{OUT} = 9.8W, P_{IN} = 0.6 W c) 1 ms pulse, 10% duty cycle, $\Theta_{JC} = 2.01^{\circ}C/W$ For T_C = 83°C, T_J = 98°C @ 50 V, 325mA, P_{OUT} = 9.8W, P_{IN} = 0.6W

d) 1 ms pulse, 20% duty cycle, Θ_{JC} = 2.56°C/W For T_C = 83°C, T_J = 101°C @ 50 V, 325 mA, P_{OUT} = 9.8 W, P_{IN} = 0.6 W

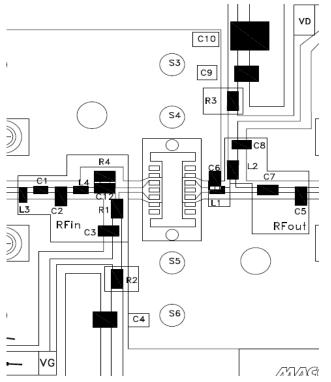
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GaN Wideband 10 W CW / Pulsed Transistor in Plastic Package DC - 3.5 GHz

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Evaluation Board Details and Recommended Tuning Solutions



Parts measured on evaluation board (8-mil thick RO4003C). Electrical and thermal ground is provided using copper-filled via hole array (not pictured), and evaluation board is mounted to a metal plate.

Matching is provided using lumped elements as shown at left. Recommended tuning solutions for 3 frequency ranges are detailed in the parts list below.

Bias Sequencing

Turning the device ON

- 1. Set V_G to the pinch-off (V_P), typically -5 V.
- 2. Turn on V_D to nominal voltage (50 V).
- 3. Increase V_{GS} until the I_{DS} current is reached.
- 4. Apply RF power to desired level.

Turning the device OFF

- 1. Turn the RF power off.
- 2. Decrease V_G down to V_{P} .
- 3. Decrease V_D down to 0 V.
- 4. Turn off V_{G} .

Parts List (N/A = not applicable for this tuning solution)

Part	Frequency = 900-1400 MHz	Frequency = 1600 MHz	Frequency = 1625-1675 MHz
C1	0402, 6.8 pF, ±5%, 200V ATC	0402, 4.7 pF, ±0.1pF, 200 V, ATC	0402, 3.3 pF, ±0.1pF, 200 V, ATC
C2	0603, 6.8 pF, ±0.1 pF, 250 V, ATC	0603, 8.2 pF, ±0.1 pF, 250 V, ATC	0603, 8.2 pF, ±0.1 pF, 250 V, ATC
C3	0603, 82 pF, ±10%, 250 V, ATC	0603, 68 pF, ±10%, 250 V, ATC	0603, 68 pF, ±10%, 250 V, ATC
C4	0805, 1000 pF, 100 V, 5%, AVX	0805, 1000 pF, 100 V, 5%, AVX	0805, 1000 pF, 100 V, 5%, AVX
C5	N/A	0603, 1.5 pF, ±0.1 pF, 250 V, ATC	N/A
C6	N/A	N/A	0603, 1.5 pF, ±0.1 pF, 250 V, ATC
C7	0603, 39 pF, ±10%, 250 V, ATC	0603, 20 pF, ±10% pF, 250 V, ATC	0603, 20 pF, ±10% pF, 250 V, ATC
C8	0603, 82 pF, ±10%, 250 V, ATC	0603, 68 pF, ±10%, 250 V, ATC	0603, 68 pF, ±10%, 250 V, ATC
C9	0805, 1000 pF, 100 V, 5%, AVX	0805, 1000 pF, 100 V, 5%, AVX	0805, 1000 pF, 100 V, 5%, AVX
C10	0805, 1000 pF, 100 V, 5%, AVX	0805, 1000 pF, 100 V, 5%, AVX	0805, 1000 pF, 100 V, 5%, AVX
C11	N/A	N/A	N/A
C12	N/A	0603, 10 pF, ±0.1 pF, 250 V, ATC	0603, 6.8 pF, ±0.1 pF, 250 V, ATC
R1	240 Ω, 0603, 5%	200 Ω, 0603, 5%	200 Ω, 0603, 5%
R2	1.0 Ω, 0603, 5%	1.0 Ω, 0603, 5%	1.0 Ω, 0603, 5%
R3	1.0 Ω, 0603, 5%	1.0 Ω, 0603, 5%	1.0 Ω, 0603, 5%
R4	8.2 Ω, 0603, 5%	33 Ω, 0603, 5%	75 Ω, 0603, 5%
L1	0402HP, 3.3 nH, 5%, Coilcraft	0402HP, 2.7 nH, 5%, Coilcraft	Shorting tab
L2	0603HP, 6.8 nH, 5%, Coilcraft	0603HP, 1.6 nH, 5%, Coilcraft	0603HP, 1.6 nH, 5%, Coilcraft
L3	0402CS, 4.3 nH, 5%, Coilcraft	0402HP, 2.7 nH, 5%, Coilcraft	0402HP, 2.7 nH, 5%, Coilcraft
L4	0402CS, 3.3nH 5% (900-1300MHz); or 2.4nH, 5% for 1000MHz-1400MHz, Coilcraft	0402HP, 2.7 nH, 5%, Coilcraft	0402HP, 2.7 nH, 5%, Coilcraft

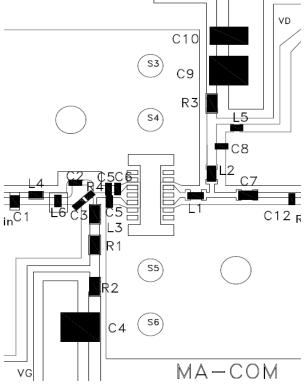
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Evaluation Board Details and Recommended Tuning Solutions— 2700-3600 MHz



Parts	List
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Part	Frequency = 2700 - 3600 MHz
C1, C12	0402 0.7 pF, ±0.05 pF, 200 V, ATC
C2	0402, 1.3 pF, ±0.05 pF, 200 V, ATC
C3	0402, 2.7 pF, ±0.1 pF, 200 V, ATC
C4, C9	0805, 1000 pF, 100 V, 5%, AVX
C5	0402, 2.2 pF, ±0.1 pF, 200 V, ATC
C6	0402, 2.0 pF, ±0.1 pF, 200 V, ATC
C7	0603, 10 pF, ±5%, 200 V, ATC
C8	0402 10 pF, ±5%, 200 V, ATC
C10	1210, 1uF, 100 V, 20%,, ATC
R1	200 Ohm, 0603, 5%
R2	Shorting tab
R3	1 Ohm, 0603, 5%
L1	Shorting tab
L2	Shorting tab
L3	0603CS, 10nH, 5%, Coilcraft
L4, L6	0402HP, 1.0nH, 5%, Coilcraft
L5	0402HP, 12nH, 5%, Coilcraft

Parts measured on evaluation board (8-mil thick RO4003C). Electrical and thermal ground is provided using copper-filled via hole array (not pictured), and evaluation board is mounted to a metal plate.

Matching is provided using lumped elements as shown at left. Recommended tuning solutions for 3 frequency ranges are detailed in the parts list below.

Bias Sequencing

Turning the device ON

- 1. Set V_G to the pinch-off (V_P), typically -5 V.
- 2. Turn on V_D to nominal voltage (50 V).
- 3. Increase V_{GS} until the I_{DS} current is reached.
- 4. Apply RF power to desired level.

Turning the device OFF

- 1. Turn the RF power off.
- 2. Decrease V_G down to V_{P} .
- 3. Decrease V_D down to 0 V.
- 4. Turn off V_G.

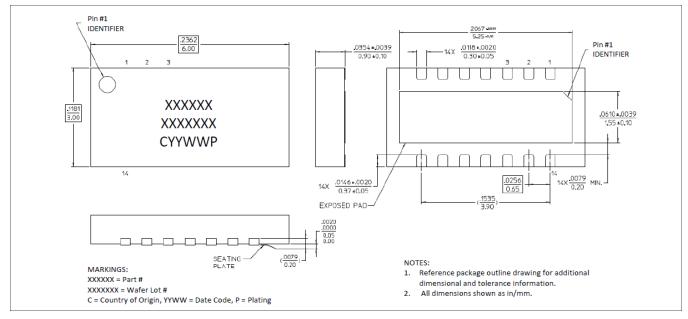
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Lead-Free 3x6 mm 14-Lead DFN[†]



† Reference Application Note S2083 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 1 requirements. Plating is Ni/Pd/Au.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Gallium Nitride Devices and Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these Class 1A devices.



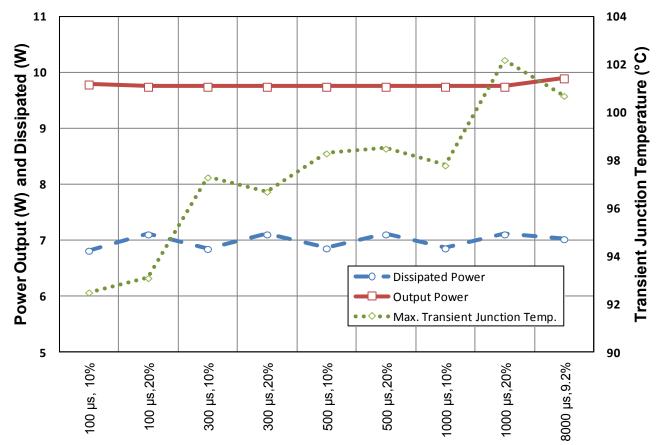
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Applications Section

Thermal Performance: Freq. = 1200 MHz, T_c = 85°C, V_{DD} = +50 V, I_{DQ} = 30 mA, Z_0 = 50 Ω

Power (Output & Dissipated) and Transient Junction Temperature vs. Pulse Duration and Duty Cycle



Pulse Width (µs), Duty Cycle (%)

Pulse Width, Duty Cycle	100 μs, 10%	100 μs, 20%	300 μs, 10%	300 μs, 20%	500 μs, 10%	500 μs, 20%	1000 μs, 10%	1000 μs, 20%	8000 μs, 9.2%
Power Dissipation (W)	6.8	7.1	6.9	7.1	6.9	7.1	6.9	7.1	7.0
1.2 GHz P _{OUT} (W)	9.79	9.75	9.75	9.75	9.75	9.75	9.75	9.75	9.90
Max. Transient Junction Temp. (°C)	92.5	93.1	97.3	96.7	98.3	98.5	97.8	102.2	100.7

Junction temperature measured using High-Speed Transient (HST) temperature detection microscopy.



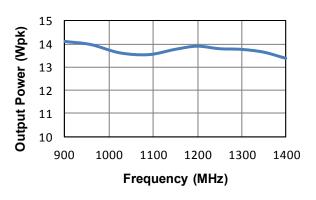
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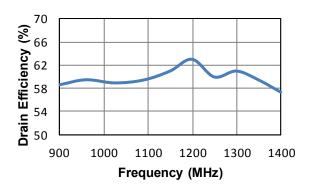
Applications Section

Typical Pulsed Performance Curves (reference 900 MHz - 1400 MHz parts list, L4 = 2.4 nH): 900 - 1400 MHz, 200 μ s Pulse, 20% Duty Cycle, P_{IN} = 0.5 W, V_{DD}= +50 V, T_A = 25°C, Z₀ = 50 Ω

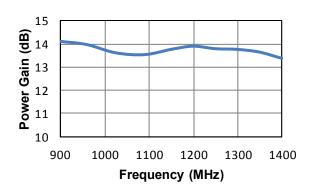
Output Power vs. Frequency



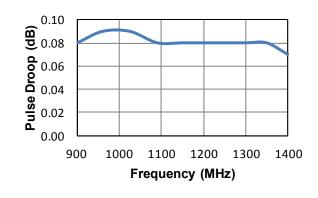
Drain Efficiency vs. Frequency



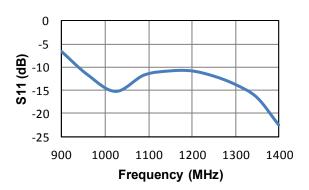
Power Gain vs. Frequency



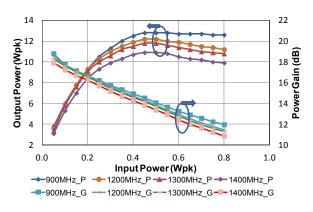
Pulse Droop vs. Frequency



Input Return Loss vs. Frequency



Output Drive & Power Gain vs. Input Power



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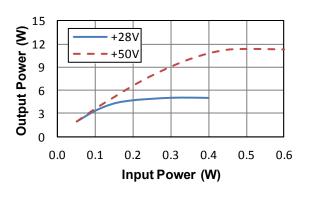
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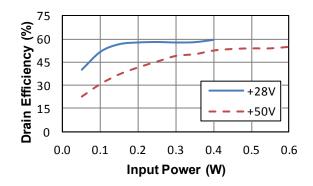
Applications Section

Typical CW Performance Curves (reference 1625MHz-1675MHz parts list): 1650 MHz, V_{DD} = +50 V/+28 V, I_{DQ} = 30 mA, CW, T_A = 25°C, Z_0 = 50 Ω

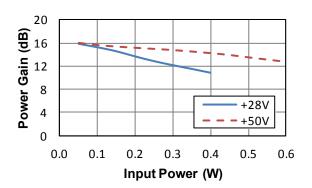
Output Power vs. Input Power



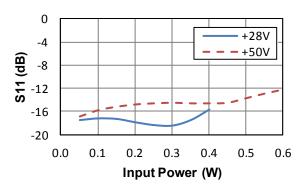
Drain Efficiency vs. Input Power



Power Gain vs. Input Power



Input Return Loss vs. Frequency





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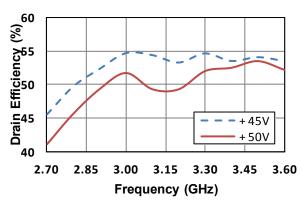
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Applications Section

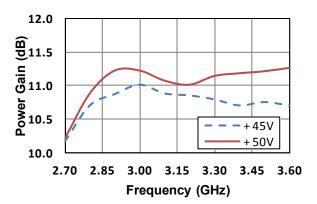
Typical S-Band Performance Curves (reference 2.7 - 3.6 GHz parts list): 2.7 - 3.6 GHz, 200 μ s Pulse, 20% Duty Cycle, P_{IN} = 0.8 W, V_{DD}= +50 V/+45 V, T_A = 25°C, Z₀ = 50 Ω

Output Power vs. Frequency

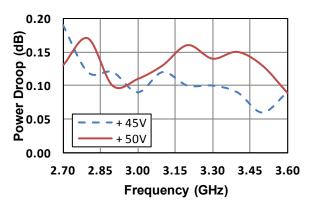
Drain Efficiency vs. Frequency



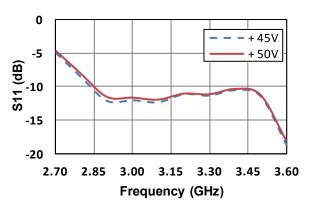
Power Gain vs. Frequency



Pulse Droop vs. Frequency



Input Return Loss vs. Frequency



¹⁰